

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to GROUND lead. ($T_j = 25^{\circ}\text{C}$ unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units	Test Conditions
V_{out}	Maximum output voltage	$V_{\text{CC}}-50$	$V_{\text{CC}}+0.3$	V	
V_{offset}	Maximum logic ground to load ground offset	$V_{\text{CC}}-50$	$V_{\text{CC}}+0.3$		
V_{in}	Maximum Input voltage	-0.3	5.5		
$V_{\text{CC max}}$	Maximum Vcc voltage	—	50		
$I_{\text{in, max.}}$	Maximum IN current	-5	10	mA	
V_{dg}	Maximum diagnostic output voltage	-0.3	5.5	V	
$I_{\text{dg, max}}$	Maximum diagnostic output current	-1	10	mA	
$I_{\text{sd cont.}}$	Diode max. permanent current ⁽¹⁾	—	2.2	A	
$I_{\text{sd pulsed}}$	Diode max. pulsed current ⁽¹⁾	—	10		
ESD1	Electrostatic discharge voltage (Human Body)	—	4	kV	C=100pF, R=1500Ω,
ESD2	Electrostatic discharge voltage (Machine Model)	—	0.5		C=200pF, R=0Ω, L=10μH
P_d	Maximum power dissipation ⁽¹⁾			W	
	(TC=25°C) IPS511	—	25		
	(rth=80°C/W) IPS511S	—	1.56		
$T_j \text{ max.}$	Max. storage & operating junction temp.	-40	+150	°C	
T_{lead}	Lead temperature (soldering 10 seconds)	—	300		

Thermal Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$R_{\text{th 1}}$	Thermal resistance junction to case	—	5	—	°C/W	TO-220
$R_{\text{th 2}}$	Thermal resistance junction to ambient	—	60	—		
$R_{\text{th 1}}$	Thermal resistance with standard footprint	—	60	—		D ² PAK (SMD220)
$R_{\text{th 2}}$	Thermal resistance with 1" square footprint	—	40	—		
$R_{\text{th 3}}$	Thermal resistance junction to case	—	5	—		

(1) Limited by junction temperature (pulsed current limited also by internal wiring)

Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Continuous V _{CC} voltage	5.5	35	V
V _{IH}	High level input voltage	4	5.5	
V _{IL}	Low level input voltage	-0.3	0.9	
I _{out} T _{amb} =85°C	Continuous output current (T _{Ambient} = 85°C, T _J = 125°C, R _{th} < 60°C/W) IPS511 (T _{Ambient} = 85°C, T _J = 125°C, R _{th} = 80°C/W) IPS511	—	1.7 1.5	A
R _{in}	Recommended resistor in series with IN pin	4	6	
R _{dg}	Recommended resistor in series with DG pin	10	20	kΩ

Static Electrical Characteristics

(T_J = 25°C, V_{CC} = 14V unless otherwise specified.)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
R _{ds(on)} @T _J =25°C	ON state resistance T _J = 25°C	—	110	135	mΩ	V _{in} = 5V, I _{out} = 2.5A
R _{ds(on)} (V _{CC} =6V)	ON state resistance @ V _{CC} = 6V	—	110	135		V _{in} = 5V, I _{out} = 1A
R _{ds(on)} @T _J =150°C	ON state resistance T _J = 150°C	—	200	—		V _{in} = 5V, I _{out} = 2.5A
V _{CC} oper.	Operating voltage range	5.5	—	35	V	
V _{clamp 1}	V _{CC} to OUT clamp voltage 1	50	56	—		I _d = 10mA (see Fig.1 & 2)
V _{clamp 2}	V _{CC} to OUT clamp voltage 2	—	58	65		I _d = I _{sd} (see Fig.1 & 2)
V _f	Body diode forward voltage	—	0.9	1.2		I _d = 2.5A, V _{in} = 0V
I _{CC} off	Supply current when OFF	—	16	50	μA	V _{in} = 0V, V _{out} = 0V
I _{CC} on	Supply current when ON	—	0.7	2	mA	V _{in} = 5V
I _{CC} ac	Ripple current when ON (AC RMS)	—	20	—	μA	V _{in} = 5V
V _{dgl}	Low level diagnostic output voltage	—	0.15	0.4	V	I _{dg} = 1.6 mA
I _{oh}	Output leakage current	—	60	110	μA	V _{out} = 6V
I _{ol}	Output leakage current	0	—	25		V _{out} = 0V
I _{dg} leakage	Diagnostic output leakage current	—	—	10		V _{dg} = 5.5V
V _{ih}	IN high threshold voltage	—	2.3	3	V	
V _{il}	IN low threshold voltage	1	1.95	—		
I _{in, on}	On state IN positive current	—	70	200	μA	V _{in} = 5V
I _n hyst.	Input hysteresis	0.1	0.25	0.5	V	

Switching Electrical Characteristics

V_{CC} = 14V, Resistive Load = 5.6Ω, T_J = 25°C, (unless otherwise specified).

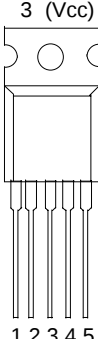
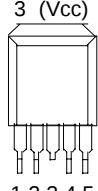
Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
T _{don}	Turn-on delay time	—	7	50	μs	See figure 3
T _{r1}	Rise time to V _{out} = V _{CC} - 5V	—	10	50		
T _{r2}	Rise time V _{CC} - 5V to V _{out} = 90% of V _{CC}	—	45	100		
dV/dt (on)	Turn ON dV/dt	—	1.3	4	V/μs	See figure 4
E _{on}	Turn ON energy	—	400	—	μJ	
T _{doff}	Turn-off delay time	—	15	50	μs	
T _f	Fall time to V _{out} = 10% of V _{CC}	—	10	50	V/μs	See figure 6
dV/dt (off)	Turn OFF dV/dt	—	2	6		
E _{off}	Turn OFF energy	—	80	—	μJ	
T _{diag}	V _{out} to V _{diag} propagation delay	—	5	15	μs	

Protection Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I _{lim}	Internal current limit	3	5	7	A	V _{out} = 0V
T _{sd+}	Over-temp. positive going threshold	—	165	—	°C	See fig. 2
T _{sd-}	Over-temp. negative going threshold	—	158	—	°C	See fig. 2
V _{sc}	Short-circuit detection voltage (3)	2	3	4	V	See fig. 2
V _{open load}	Open load detection threshold	2	3	4	V	

(3) Referenced to V_{CC}

Lead Assignments

 1 2 3 4 5 5 Lead - TO220	1 - Ground 2 - In 3 - V_{CC} 4 - DG 5 - Out	 1 2 3 4 5 5 Lead - D ² PAK (SMD220)
IPS511		IPS511S
Part Number		

Functional Block Diagram

All values are typical

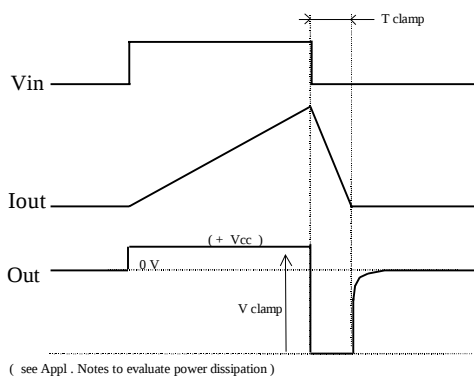
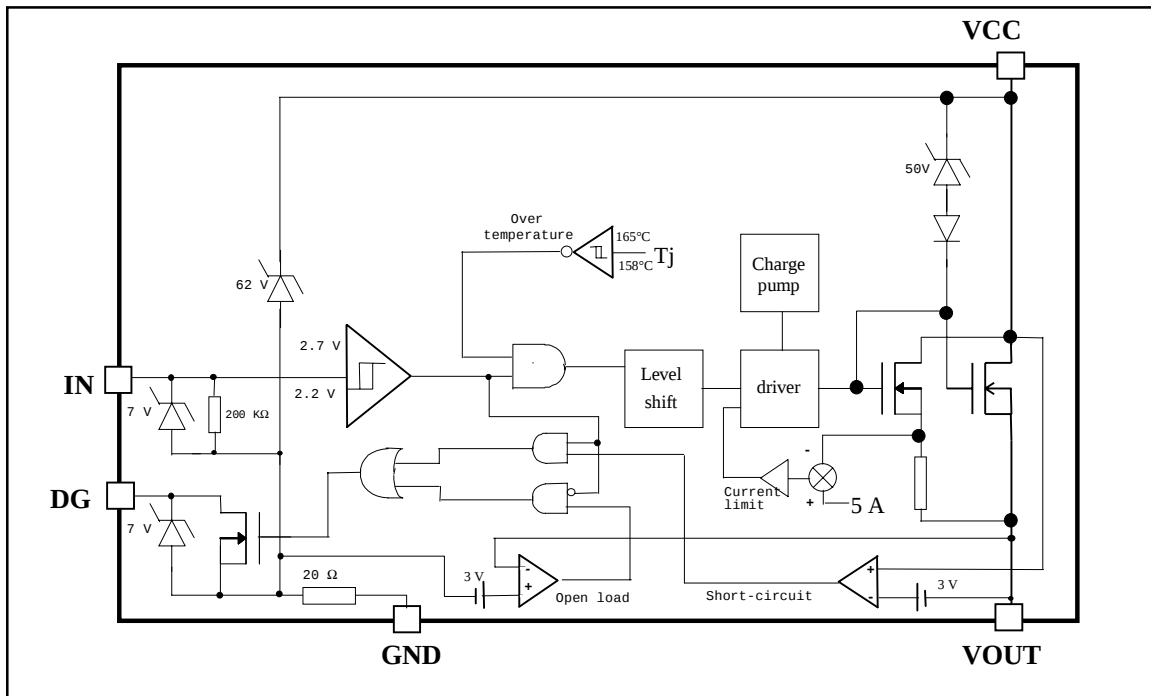


Figure 1 - Active clamp waveforms

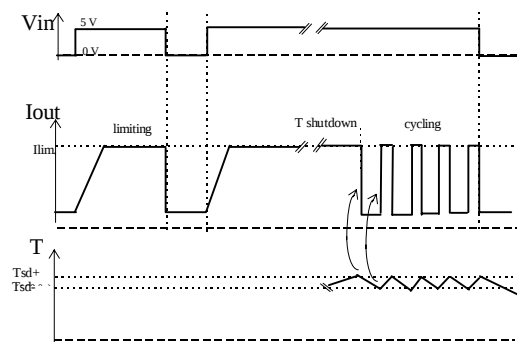


Figure 2 - Protection timing diagram

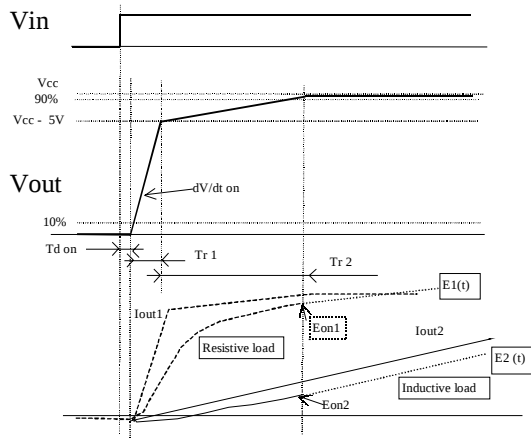


Figure 3 - Switching times definition (turn-on)
Turn on energy with a resistive or an inductive load

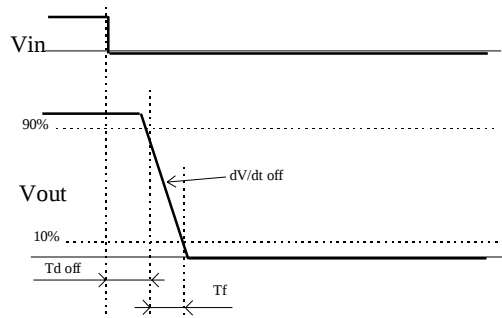


Figure 4 - Switching times definition (turn-off)

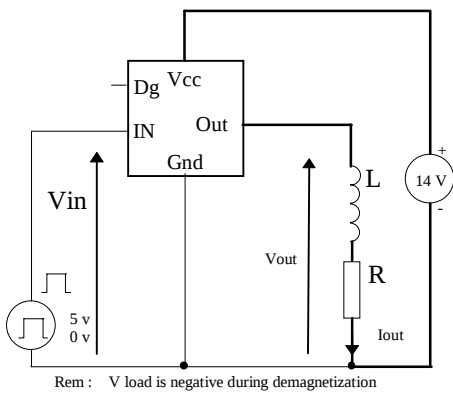


Figure 5 - Active clamp test circuit

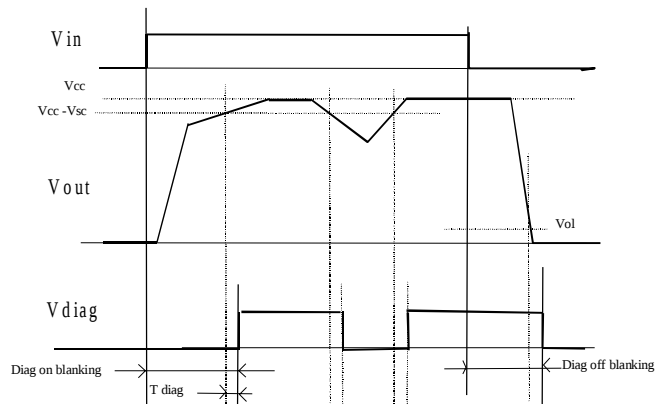


Figure 6 - Diagnostic delay definitions

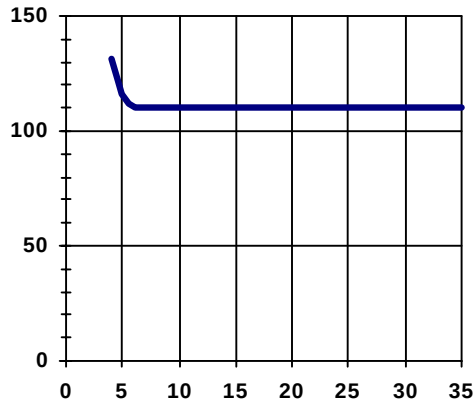


Figure 7 - R_{ds(on)} (mΩ) Vs V_{CC} (V)

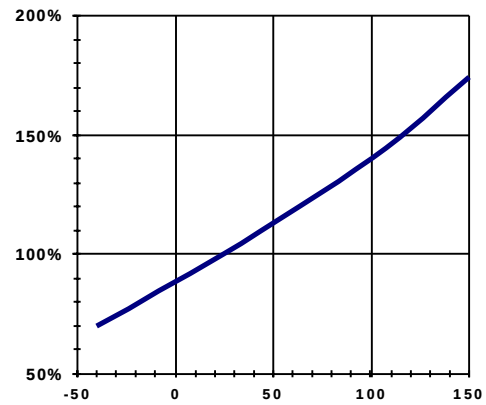


Figure 8 - Normalized R_{ds(on)} (%) Vs T_j (°C)

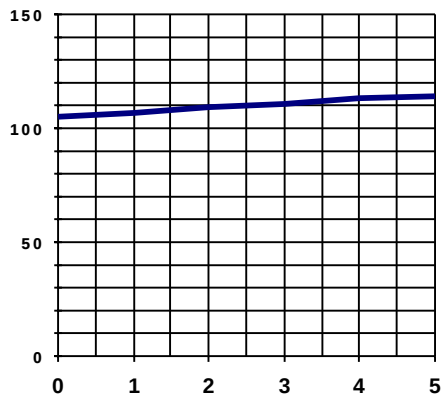


Figure 9 - R_{ds(on)} (mΩ) Vs I_{out} (A)

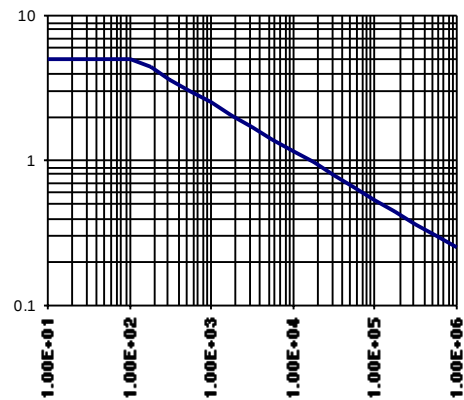


Figure 10 - Max. I_{out} (A) Vs Load Inductance (μH)

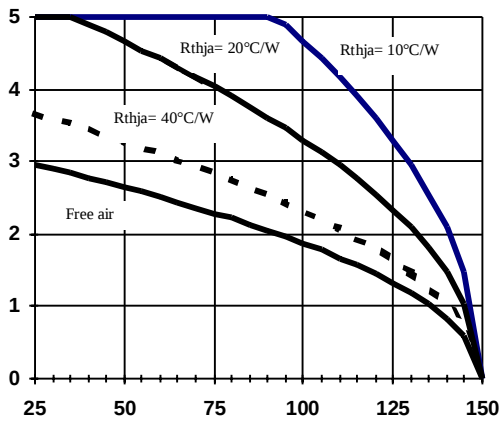


Figure 11a - Max load current (A) Vs Tamb (°C)
IPS511

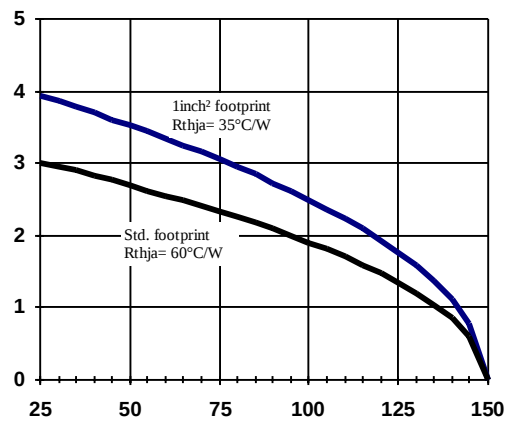


Figure 11b - Max load current (A) Vs Tamb (°C)
IPS511S

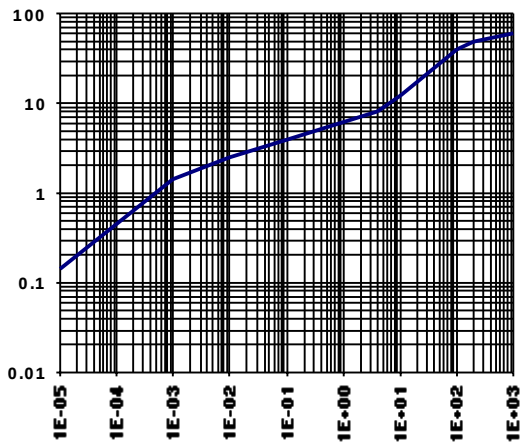


Figure 12 - Transient Thermal Impedance (°C/W)
Vs Time (S)

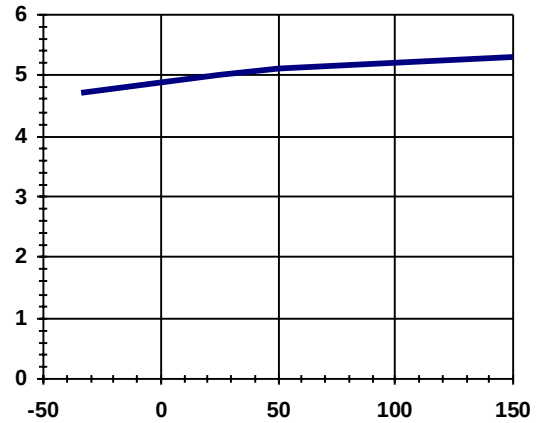


Figure 13 - Ilim (A) Vs Tj (°C)

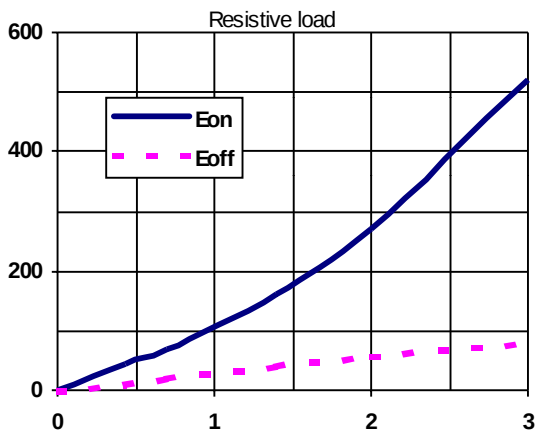


Figure 14 - Eon, Eoff (μJ) (A) Vs Iout (A)

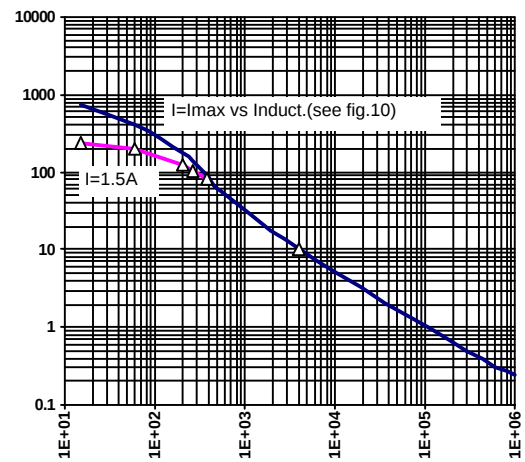


Figure 15 - Eon (μJ) Vs Load Inductance (μH)
(see Fig. 3)

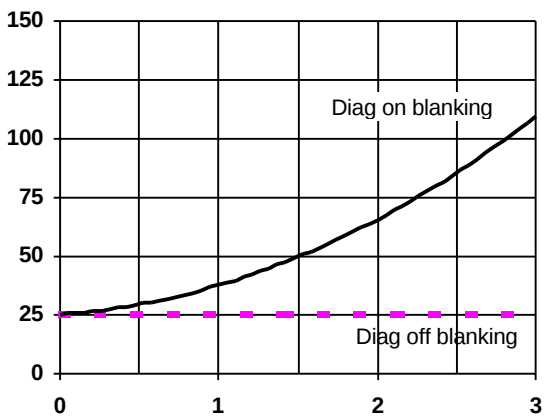


Figure 16 - Diag Blanking time (μS) Vs Iout (A)
(resistive load - see Fig. 6)

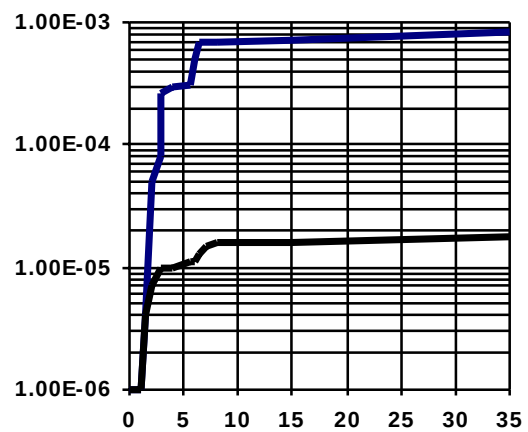


Figure 17 - ICC (mA) Vs VCC (V)

IPS511/IPS511S

International
IR Rectifier

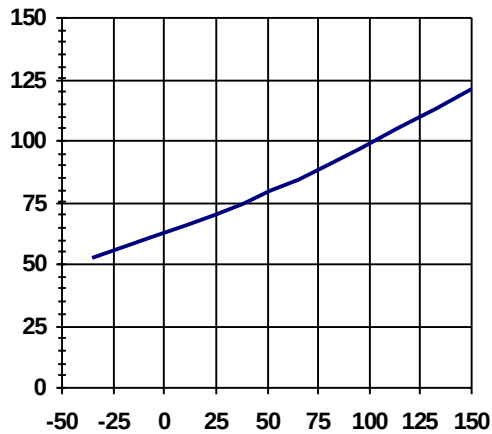
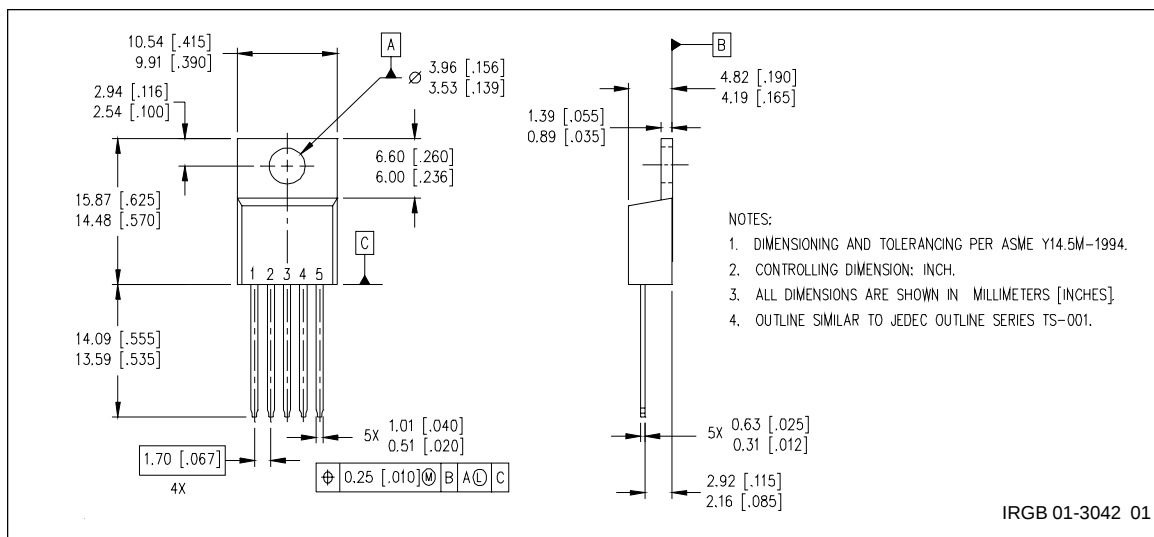
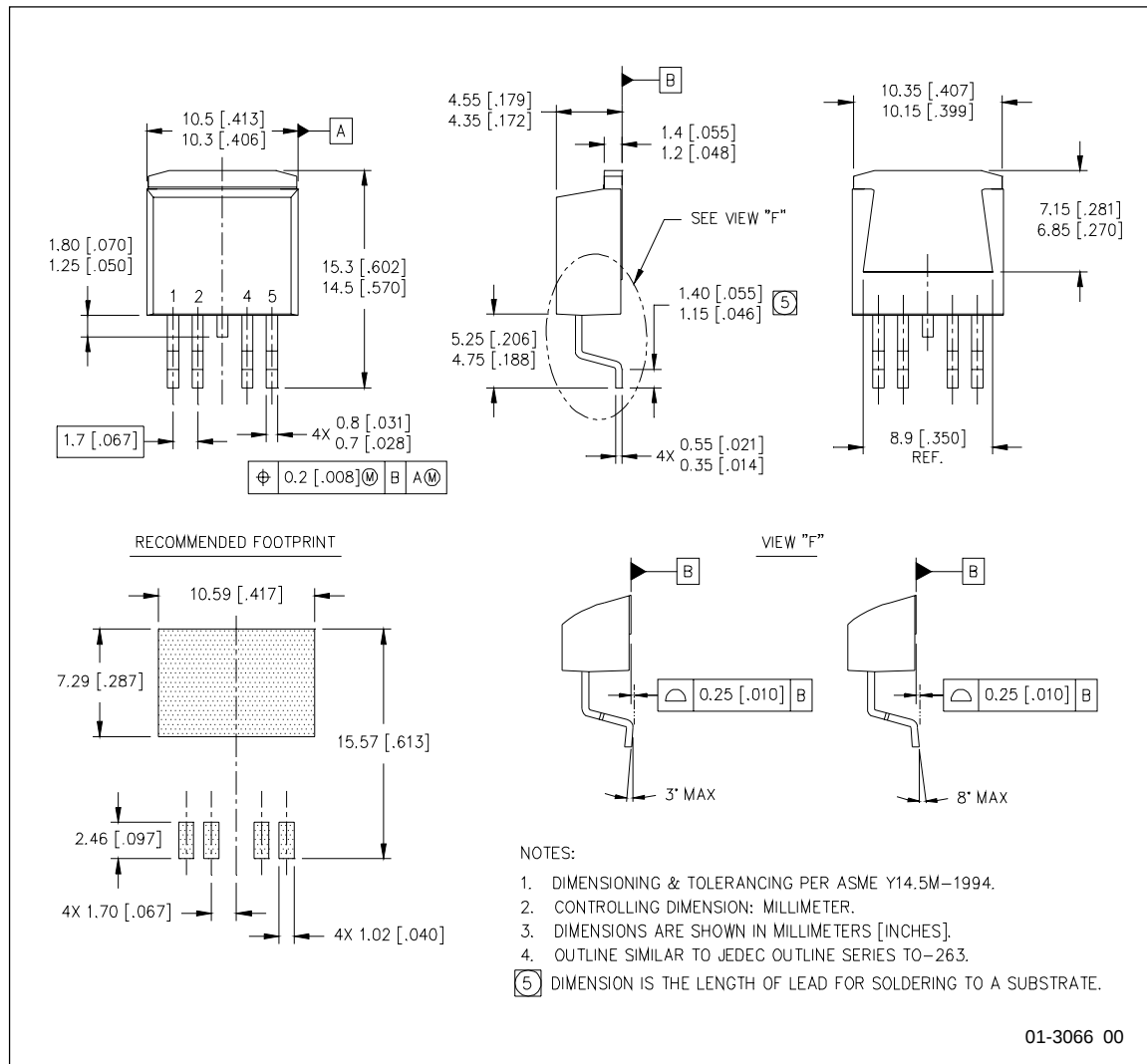


Figure 18 - I_{in} @ $V_{in} = 5V$ (μA) Vs T_j ($^{\circ}C$)

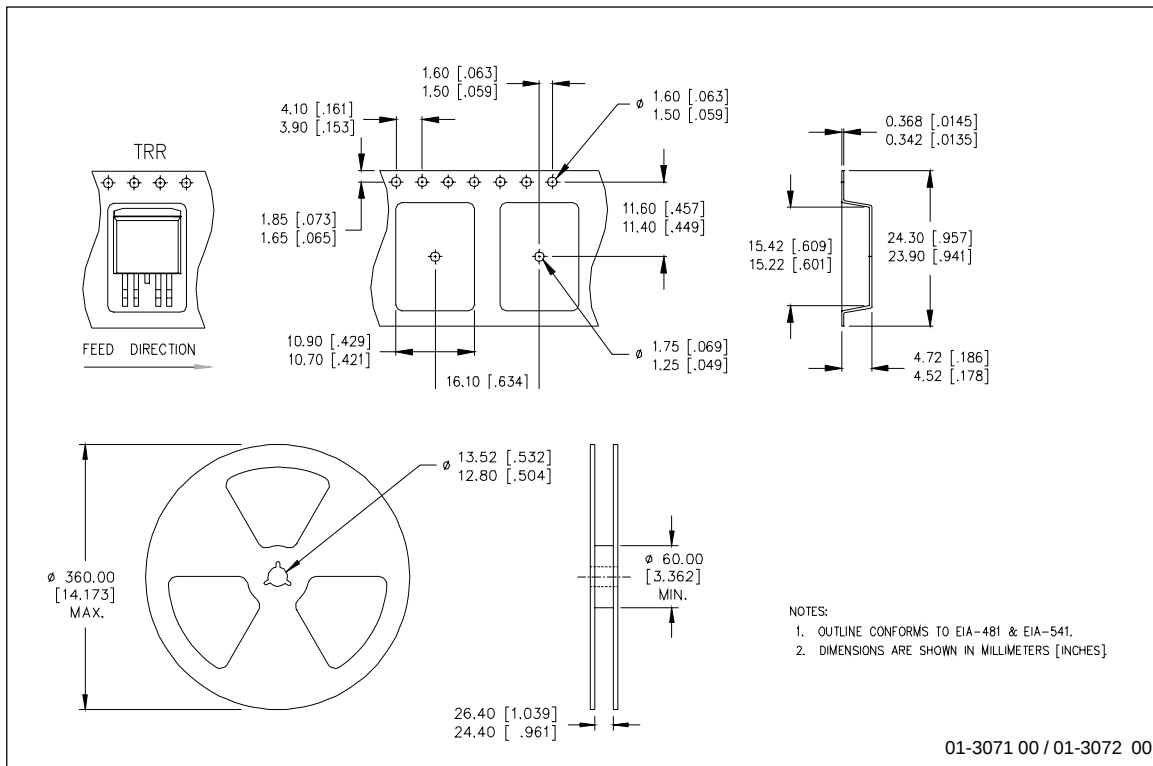
Case Outline 5 Lead - TO220



Case Outline 5 Lead - D²PAK (SMD220)



Tape & Reel 5 Lead - D²PAK (SMD220)



Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>